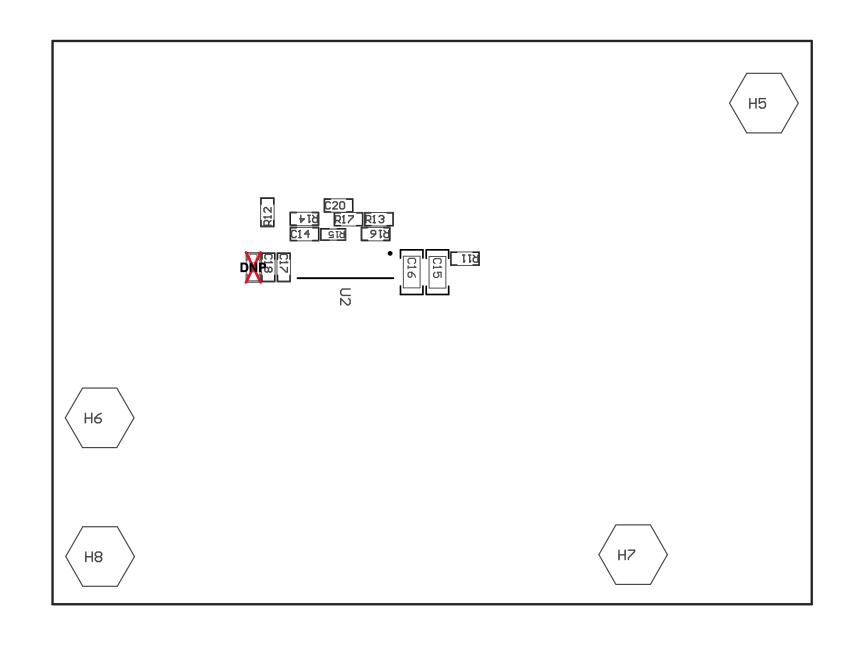


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: TIDA-00177_production

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00177	REV: Rev E1	SUN REV:	Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 6/25/2	2015 12:33:19	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: TIDA-00177_production

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00177	REV: Rev E1	SUN REV:	Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/25/2	2015 12:33:21	PM	TEXAS INSTRUMENTS

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